Press Pack IEGT Silicon N-Channel IEGT

ST3000GXH35A

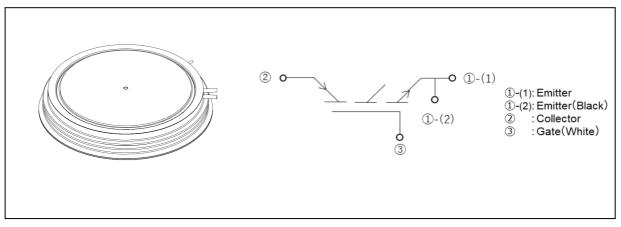
1. Applications

- Electric power transmission and distribution
- Motor Controllers
- High-Power Switching

2. Features

- (1) High reliability due to hermetic sealing structure.
- (2) Double side cooling type.

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_c = 25$ °C, unless otherwise specified)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Collector-emitter voltage	V _{CES}			4500	V
Gate-emitter voltage	V _{GES}			±20	V
Collector current (DC)	Ι _C	(Note 1)		3000	Α
Collector current (pulsed)	I _{CP}	(Note 2)		6000	А
Collector power dissipation	Pc	(Note 3)	T _f = 25 °C	25879	W
Junction temperature	Tj			-40 to 150	°C
Operating junction temperature	T _{j(opr)}			-40 to 125	°C
Storage temperature	T _{stg}			-40 to 125	°C
Mounting force	_			59 to 70	kN

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: T_f = 105 °C

Note 2: Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed maximum T_j rating. Note 3: Refer to the application notes.

5. Thermal Characteristics (Note)

Characteristics	Symbol	Note	Test Condition	Max	Unit
Thermal resistance (junction-to-fin)	R _{th(j-f)}	(Note4)	Double side	4.83	K/kW

Note: Customers must also refer to and comply with the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and the instructions for the application with which the Product will be used with or for.

Note4: Conductive thermal compound is added.

6. Electrical Characteristics

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate-emitter leakage current	I _{GES}	V_{GE} = ±20 V, V_{CE} = 0 V, T_{j} = 25 °C	_	_	±100	nA
Collector-emitter cut-off current	I _{CES}	V _{CE} = 4500 V, V _{GE} = 0 V, T _j = 25 °C	_	_	0.2	mA
Gate-emitter cut-off voltage	V _{GE(off)}	I _C = 3.0 A, V _{CE} = 5 V, T _j = 25 °C	6.70	7.20	7.70	V
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 3000 A, V _{GE} = 15 V, T _j = 25 °C		2.10	—	V
		I _C = 3000 A, V _{GE} = 15 V, T _j = 150 °C	_	2.60	3.05	
Input capacitance	C _{ies}	V _{CE} = 10 V, V _{GE} = 0 V, f = 100 kHz, T _j = 25 ℃	_	402	_	nF
Switching time (rise time)	tr	$\label{eq:VCC} \begin{array}{l} V_{CC} = 2800 \ \text{V}, \ \text{I}_{C} = 3000 \ \text{A}, \\ R_{G(on)} = 2.2 \ \Omega, \ R_{G(off)} = 39 \ \Omega, \\ V_{GE} = \pm 15 \ \text{V}, \ \text{T}_{j} = 150 \ ^{\circ}\text{C} \\ \text{Diode:} 3000\text{GXHH32} \\ \text{T}_{j} = 150 \ ^{\circ}\text{C} \\ (\text{Inductive load, } \ \text{L}_{s} \approx 300 \ \text{nH}) \\ \text{See Fig. 6.1 and Fig. 6.2} \end{array}$	_	0.44	_	μS
Switching time (turn-on delay time)	t _{d(on)}		_	0.38	_	μS
Switching time (turn-on time)	t _{on}		_	0.82	_	μS
Switching time (fall time)	t _f		_	2.20	_	μS
Switching time (turn-off delay time)	t _{d(off)}			11.40	_	μS
Switching time (turn-off time)	t _{off}		_	13.60	_	μS
Turn-on switching loss	Eon		_	8.00	_	J
Turn-off switching loss	E _{off}		_	20.00	—	J
Short-circuit pulse width	t _{psc}		_	—	10	μS

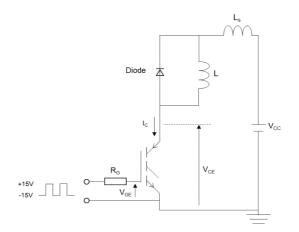


Fig. 6.1 Test Circuit

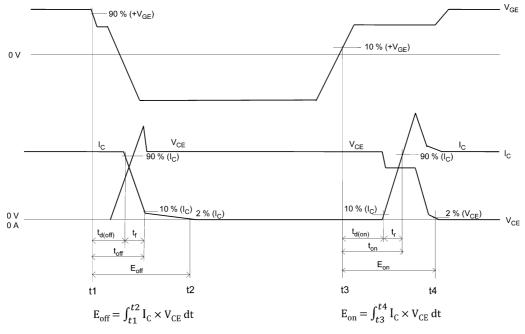
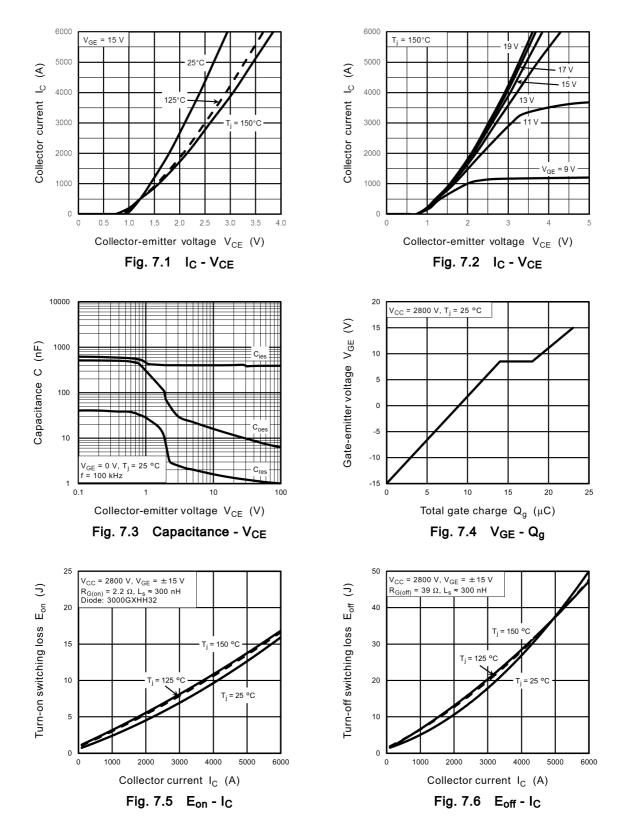
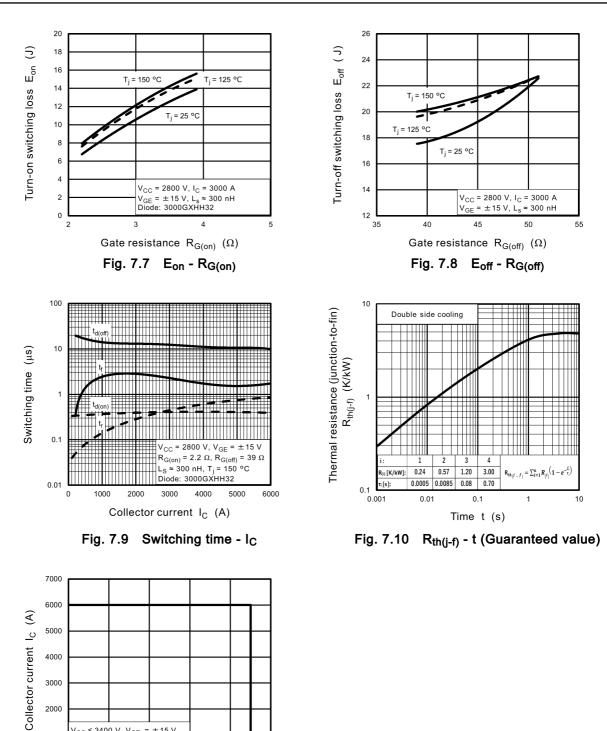


Fig. 6.2 Timing Chart

7. Characteristics Curves (Note)





Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

 $V_{CC} \le 3400 \text{ V}, \text{ V}_{GE} = \pm 15 \text{ V}$

2000

3000

Collector-emitter voltage V_{CE} (V) Fig. 7.11 RBSOA (Guaranteed value)

4000

5000

 $R_{G(off)} \ge 39 \Omega, L_s \le 240 nH$

1000

T_i ≤ 150 °C

4000 3000 2000

1000

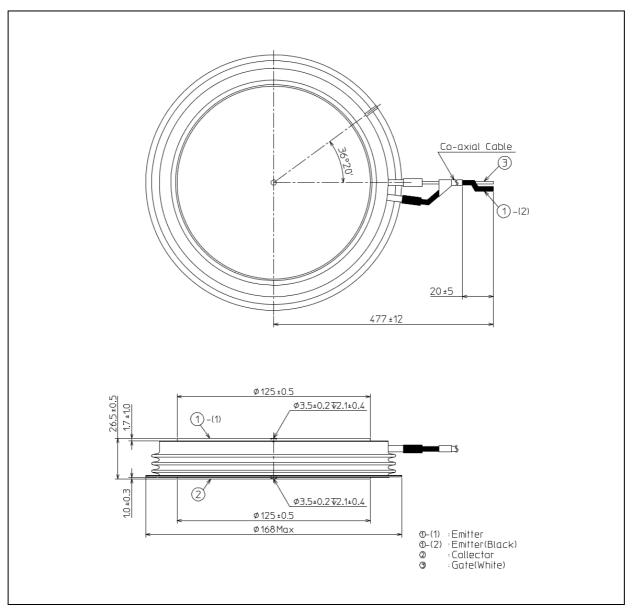
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ST3000GXH35A

Package Dimensions

Unit: mm



Weight: 2700 g (typ.)

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	Package Name(s)
OSHIBA: 2-168A2S	

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